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(12) **United States Design Patent** (10) **Patent No.:** **US D978,939 S**
Pratginestos et al. (45) **Date of Patent:** **** Feb. 21, 2023**

- (54) **SOLDERING PASTE DISPENSER**
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- (52) **U.S. Cl.**
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- (58) **Field of Classification Search**
 USPC D8/29.1, 29.2, 30; D14/126; D15/122, D15/144, 144.1, 144.2
 CPC B23K 3/08; B23K 3/033; B23K 3/0369; G05D 23/2401
 See application file for complete search history.

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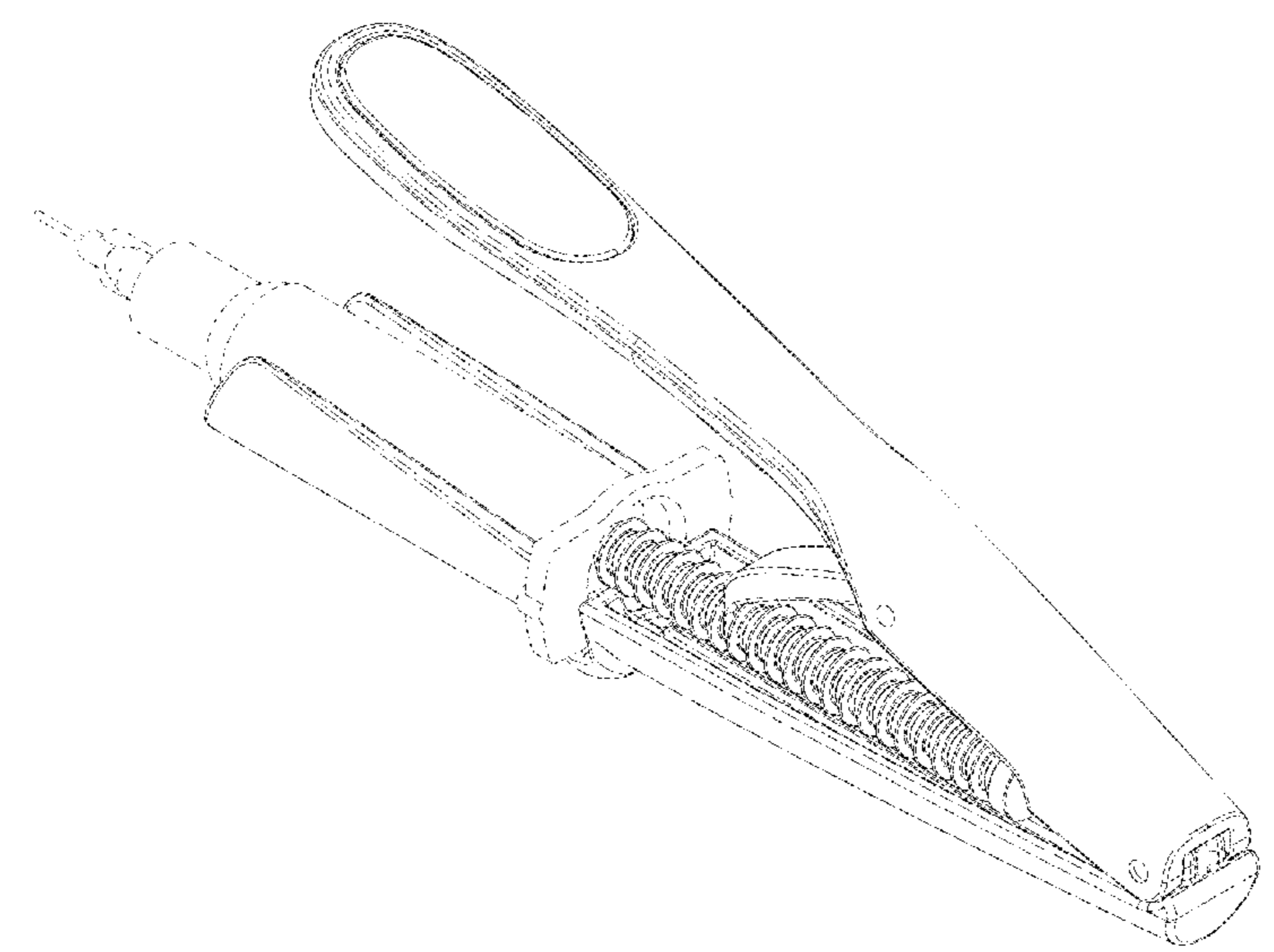
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(57) **CLAIM**
The ornamental design for a soldering paste dispenser, as shown and described.

DESCRIPTION
1. Soldering paste dispenser
1.1 is a perspective view of a soldering paste dispenser embodying our new design;
1.2 is a front elevation view thereof;
1.3 is a right side elevation view thereof;
1.4 is a top plan view thereof;
1.5 is a left side elevation view thereof;
1.6 is a bottom plan view thereof; and
1.7 is a rear elevation view thereof.
The parts shown by means of broken lines in the reproductions are not part of the claimed design.

1 Claim, 7 Drawing Sheets



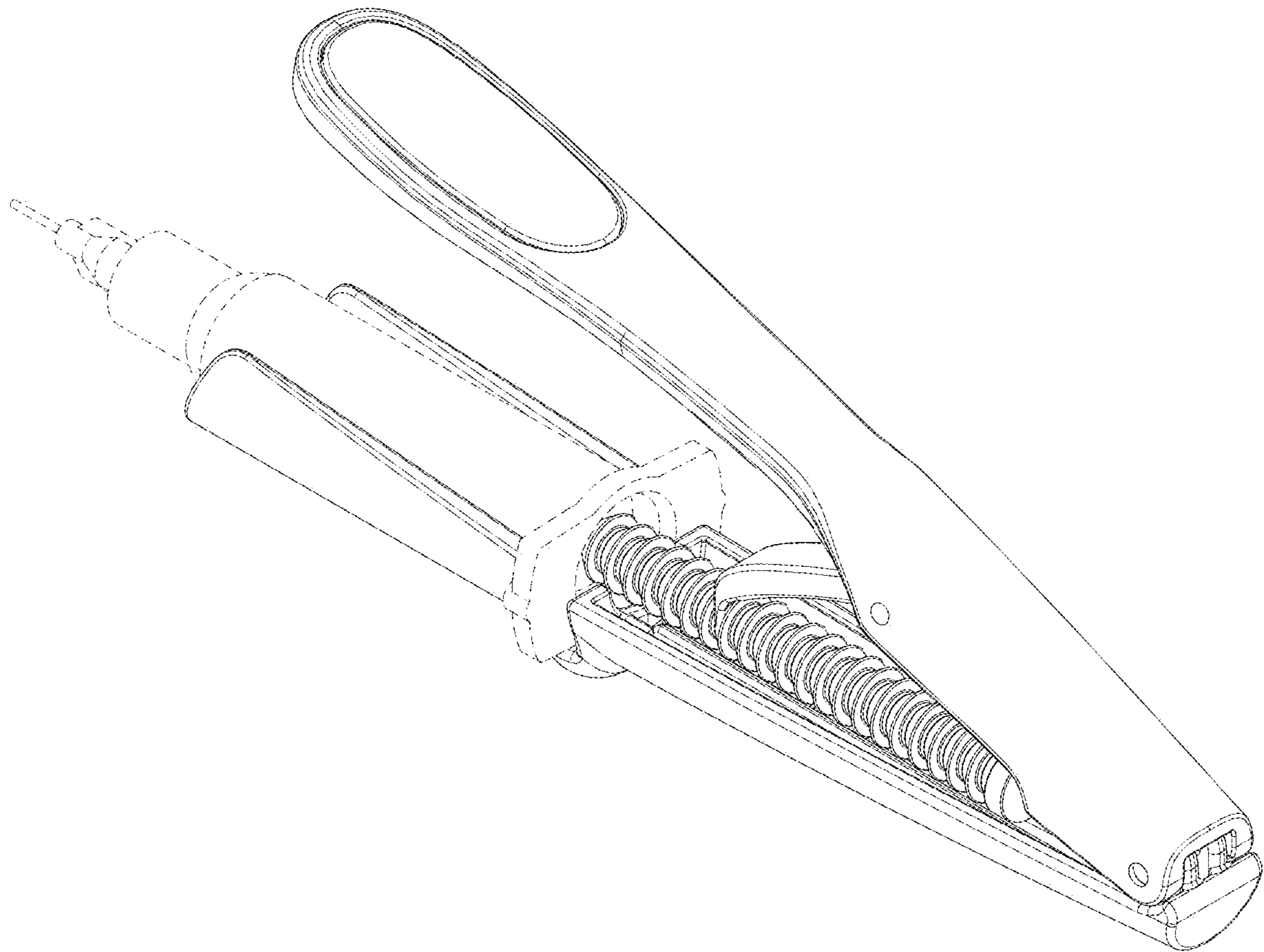
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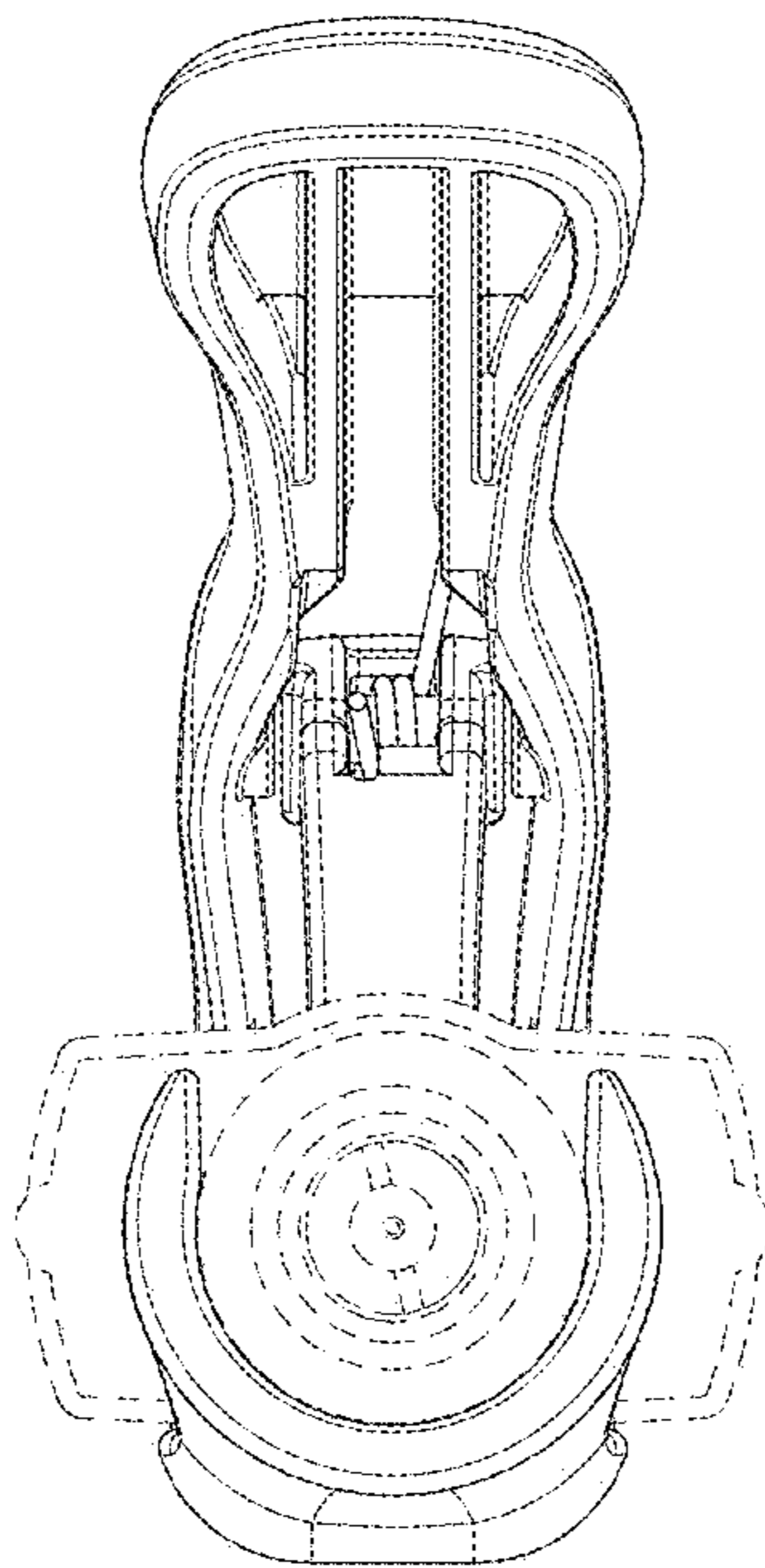
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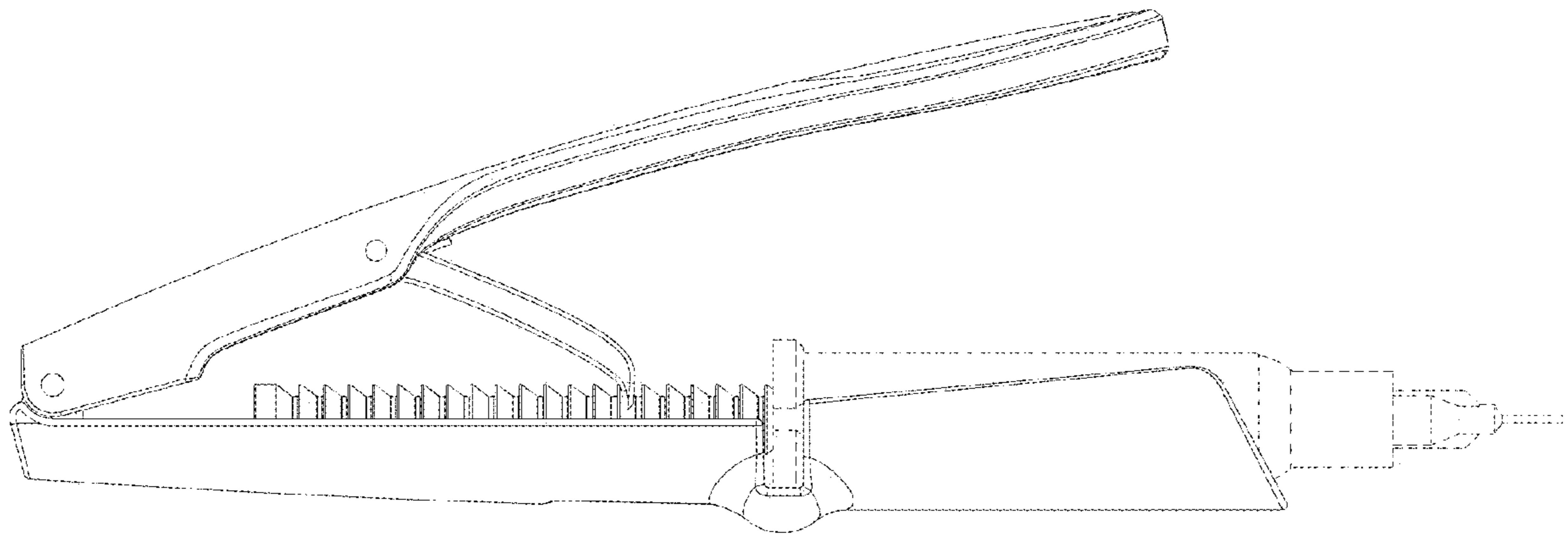
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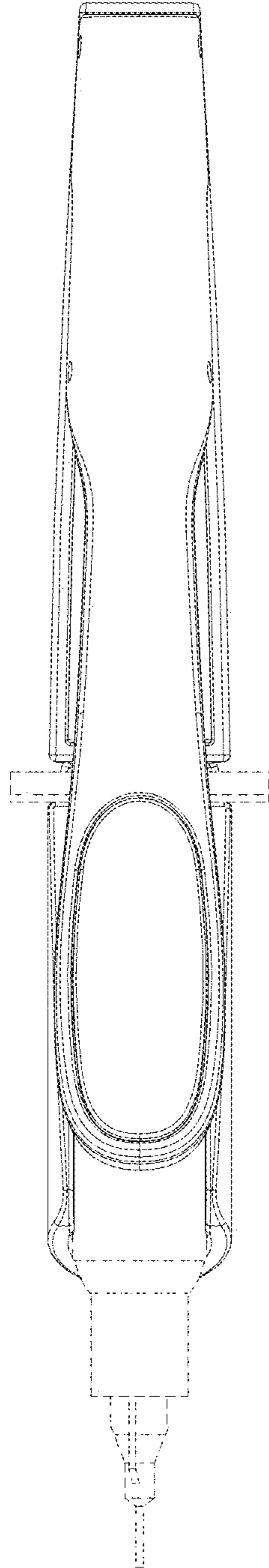
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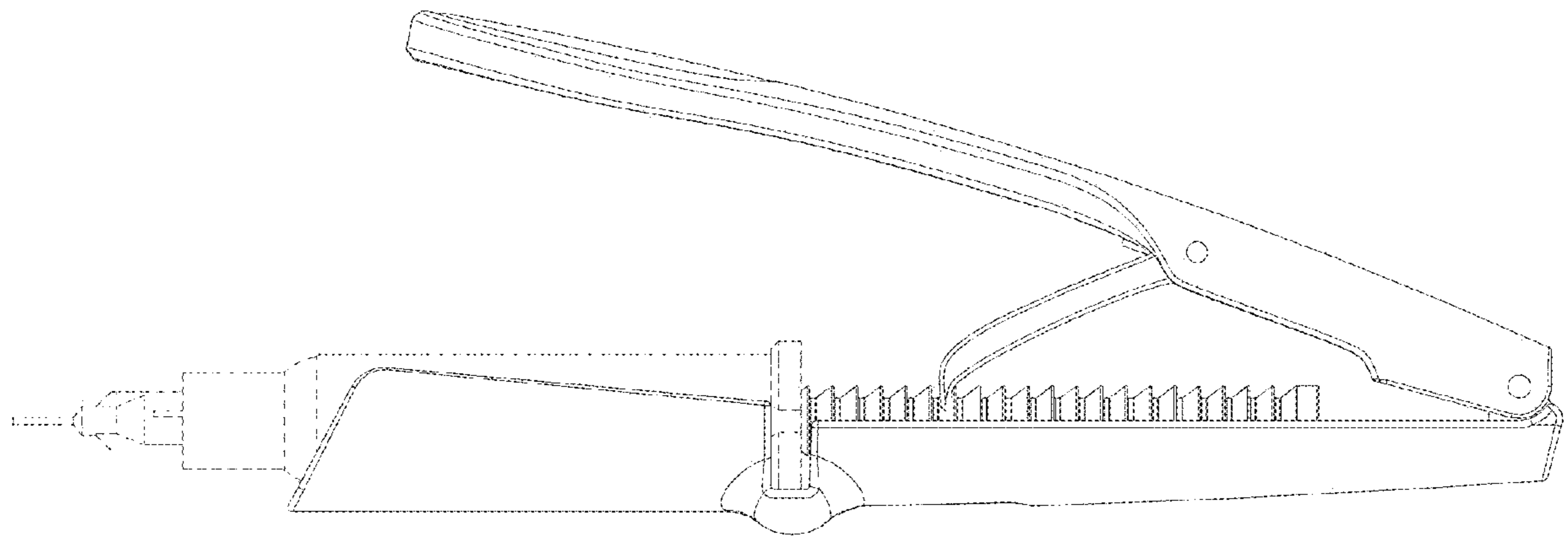
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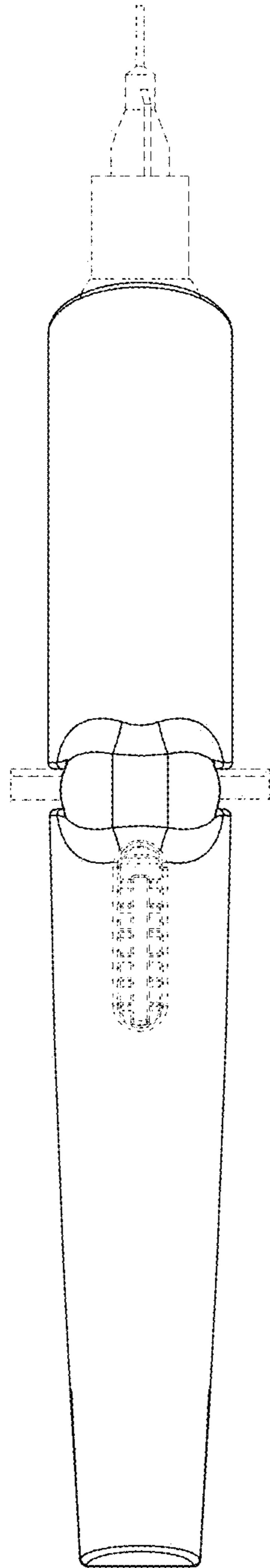
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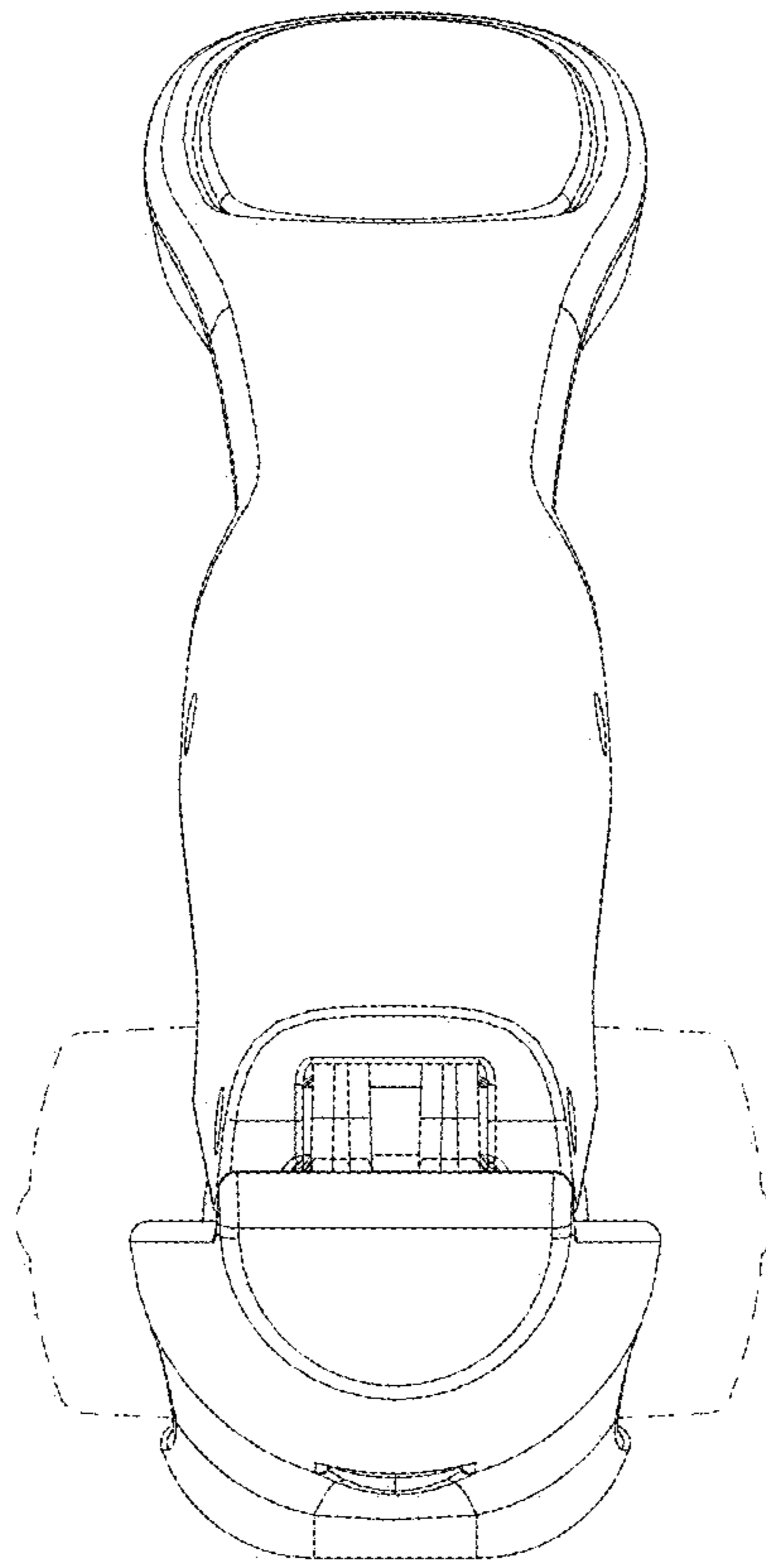
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1.5



1.6



1.7